

**Amendments to the Claims:**

Kindly replace the previous claim set with the claim set which appears below, in which Claims 3-5 have been cancelled without prejudice or disclaimer of that which is defined thereby, Claim 14 has been added and Claim 1 has been amended to read as follows:

1. (Currently Amended) A cationically epoxy resin composition comprising:

(a) an epoxy resin component comprising the combination of bisphenol A epoxy resin, hydrogenated bisphenol A epoxy resin and dicyclopentadiene epoxy resin;

(b) a cationic photo-initiator;

(c) a cationic thermal-initiator and

(d) a filler selected from the group consisting of oxides, hydroxides and carbonates containing a Group II element in the long periodic table.

2. (Original) A composition according to claim 1, wherein the composition comprises 0.1 to 10 parts by weight of cationic photo-initiator, 0.01 to 5 parts by weight of the cationic thermal-initiator and 1 to 100 parts by weight of the filler each based on the 100 parts by weight of the epoxy resin component.

Claims 3-5. (Cancelled)

6. (Original) A composition according to claim 1, wherein the cationic photo-initiator is a salt represented by  $A^+B$  which produces cationic active species by irradiation of light; the cation  $A^+$  selected from the group consisting of aromatic iodonium ions and aromatic sulfonium ions.

7. (Original) A composition according to claim 1, wherein the cationic thermal-initiator is a salt represented by  $A^+B$  which produces cationic active species by heat; the cation  $A^+$  is selected from the group consisting of sulfonium ions in which at least one among three groups bonding to the S-atom is alkyl group and sulfonium ions in which two among three groups bonding to the S-atom form together an alkylene group to form a ring with S-atom.

8. (Original) A composition according to claim 6, wherein the anion B in the cationic photo-initiator is selected from the group consisting of  $SbF_6^-$ ;  $PF_6^-$ ;  $AsF_6^-$ ;  $BF_4^-$  and  $B(aryl)_4^-$ .

9. (Original) A composition according to claim 7, wherein the anion B in the cationic thermal-initiator is selected from the group consisting of  $SbF_6^-$ ;  $PF_6^-$ ;  $AsF_6^-$ ;  $BF_4^-$ ; and  $B(aryl)_4^-$ .

10. (Original) A composition according to claim 1, further comprising a polyol compound.

11. (Original) A composition according to claim 1, wherein the Group II element in the (C) filler is selected from the group consisting of magnesium, calcium and barium.

12. (Original) A composition according to claim 11, wherein the Group II element in the (C) filler is magnesium.

13. (Original) A composition according to claim 1, wherein the (C) filler is selected from the group consisting of MgO, Mg(OH)<sub>2</sub>, talc, cordierite, magnesium meta-silicate and magnesium ortho-silicate.

14. (New) A semiconductor device package comprising at least two substrates, at least one of which being constructed from glass, sealed by the product of UV radiation exposure on the composition of Claim 1.